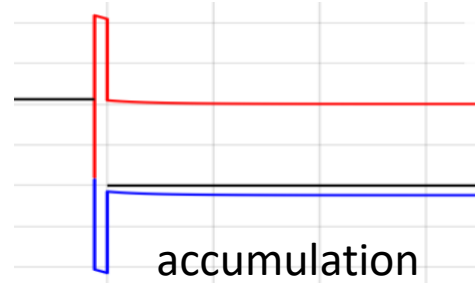


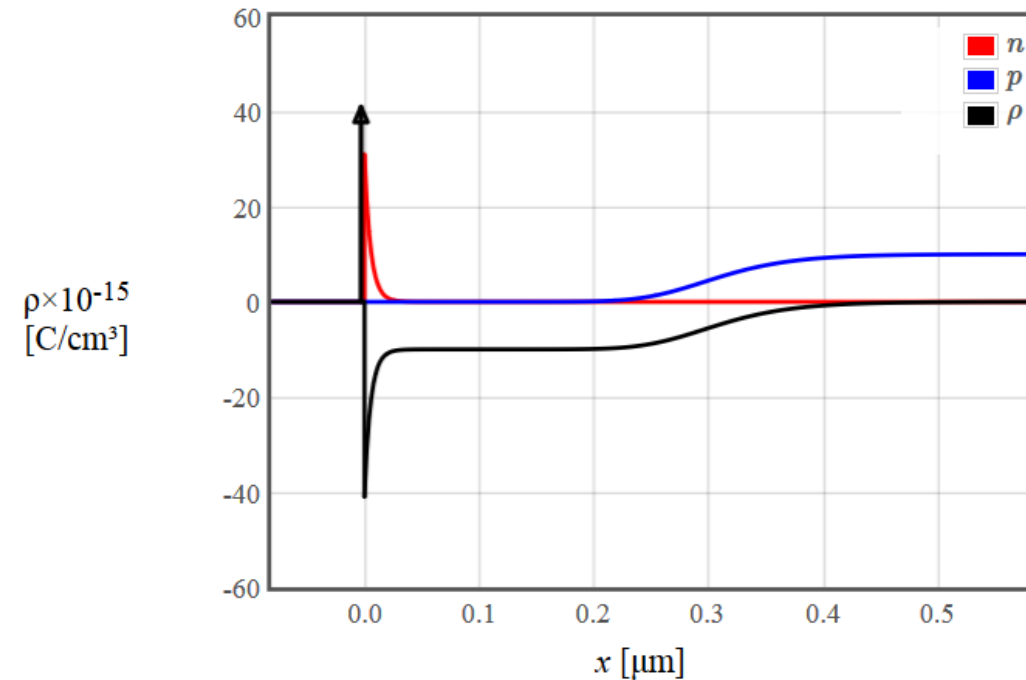
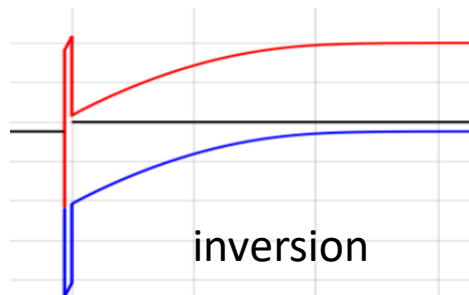
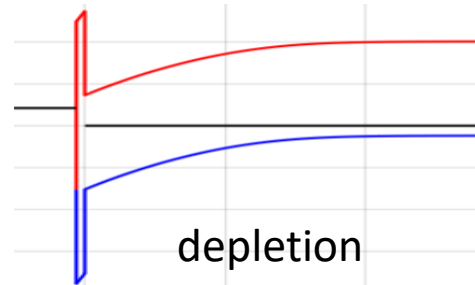
10

MOSFETs: Gradual Channel Approximation

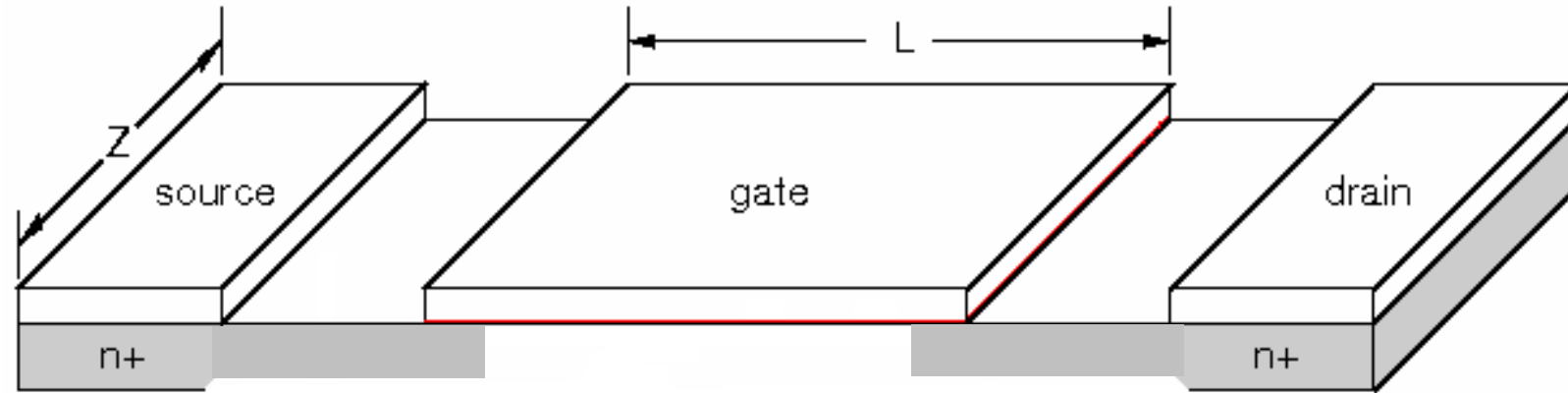
Gradual channel approximation



$$Q_{\text{mobile}} = \begin{cases} 0, & \text{for } V_G - V_B < V_T \\ -C_{\text{ox}}(V_G - V_B - V_T) & \text{for } V_G - V_B > V_T \end{cases}$$



Gradual channel approximation



$$j = -nev_d = ne\mu_n E_y \quad \text{Ohm's law}$$

$$I = Ztj = Zt ne\mu_n E_y = Z e\mu_n n_s E_y$$

$n_s = n t$ is the sheet charge at the interface

$$n_s(y) = -\frac{Q}{e} = \frac{C_{ox}(V_G - V_{ch}(y) - V_T)}{e}$$

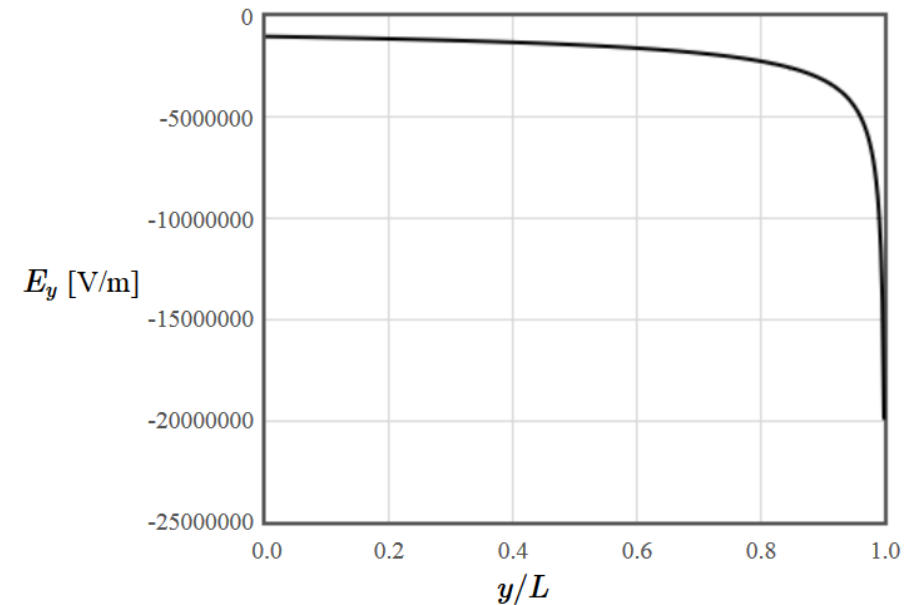
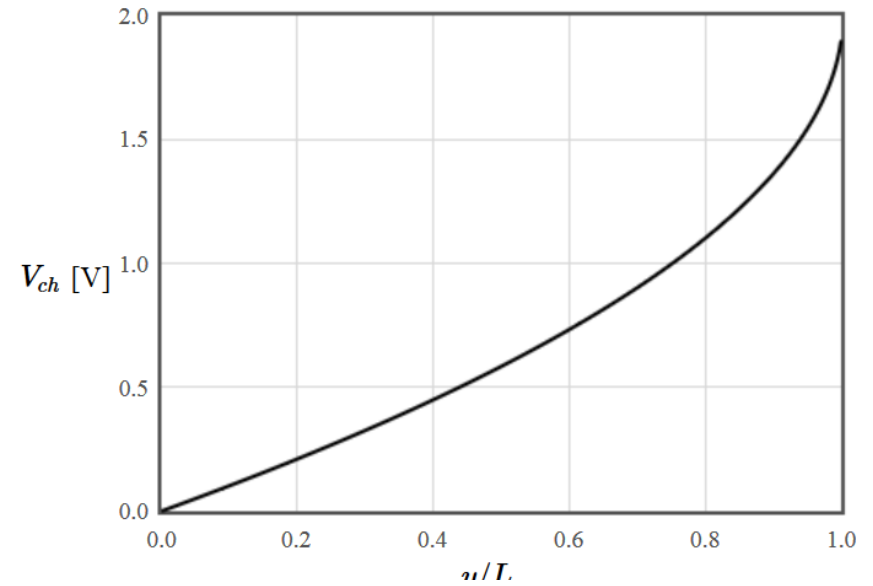
$$I_D = -Z\mu_n C_{ox}(V_G - V_{ch}(y) - V_T) \frac{dV_{ch}}{dy}$$

differential equation for V_{ch}

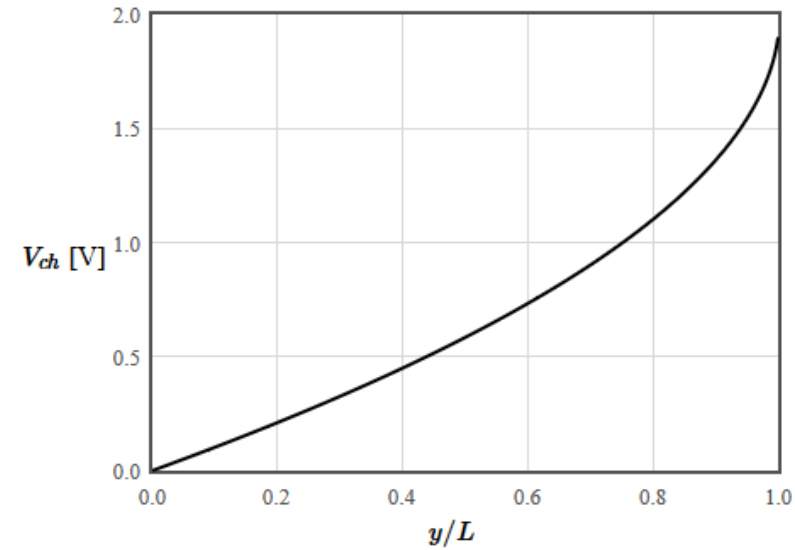
Gradual channel approximation

$$V_{ch}(y) = V_G - V_T - \sqrt{(V_G - V_T)^2 - \frac{2I_D y}{Z\mu_n C_{ox}}}$$

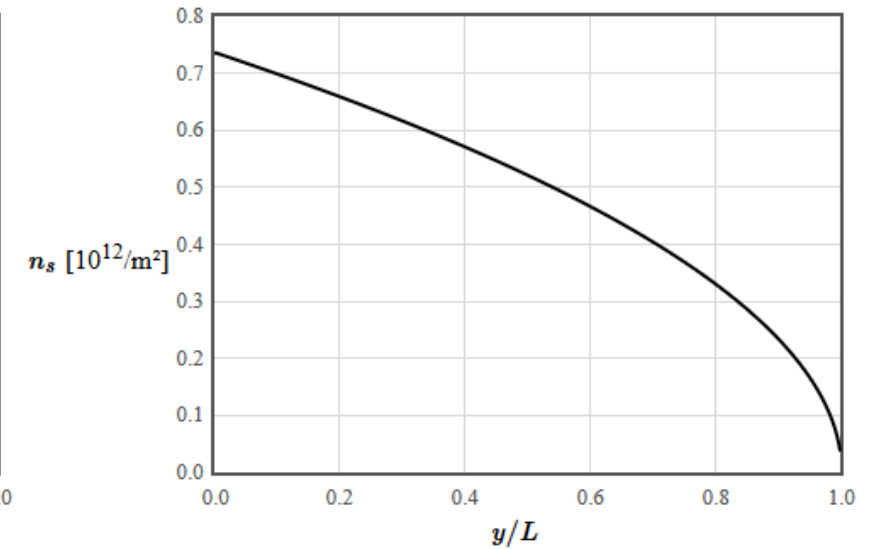
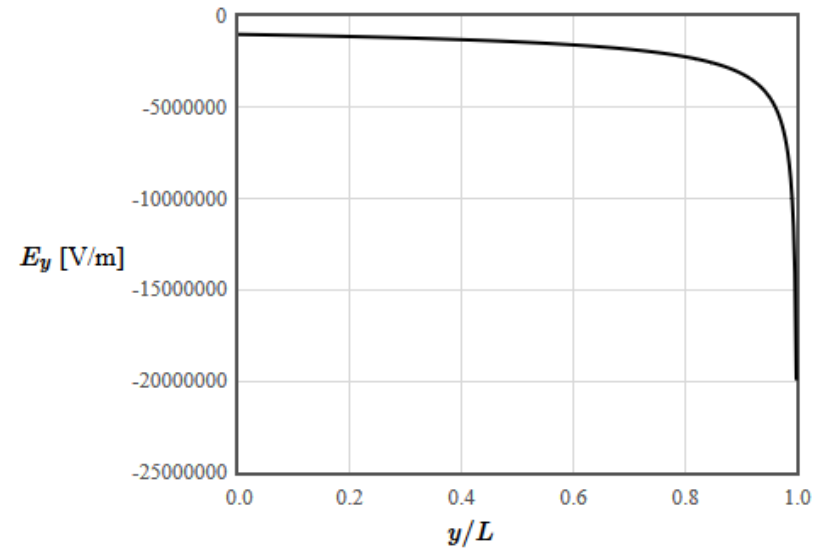
$$E_y = -\frac{dV_{ch}}{dy} = -\frac{I_D}{Z\mu_n C_{ox} \sqrt{(V_G - V_T)^2 - \frac{2I_D y}{Z\mu_n C_{ox}}}}$$



Gradual channel approximation



Z	1E-5	m
L	1E-6	m
μ_n	1500	cm^2/Vs
ϵ_r	4	
t_{ox}	3E-9	m
V_D	1.9	V
V_G	3	V
V_T	1	V
Replot		

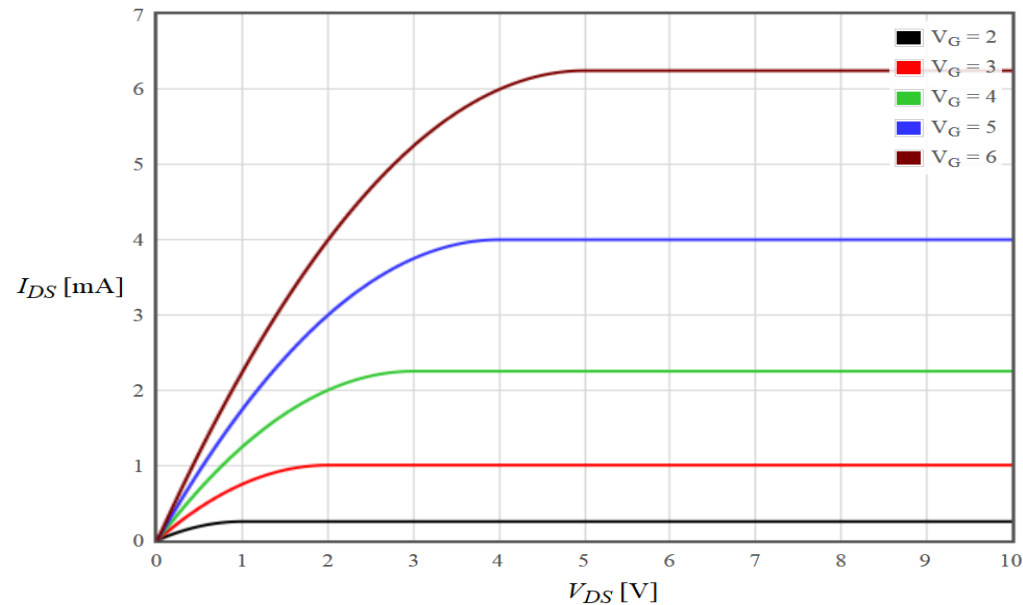


Gradual channel approximation

$$\int_0^L I_D dy = \int_0^{V_D} Z \mu_n C_{ox} (V_G - V_{ch}(y) - V_T) dV$$

$$I_D = \frac{Z}{L} \mu_n C_{ox} \left[(V_G - V_T) V_D - \frac{V_D^2}{2} \right]$$

valid in the linear regime (until pinch-off occurs at the drain)



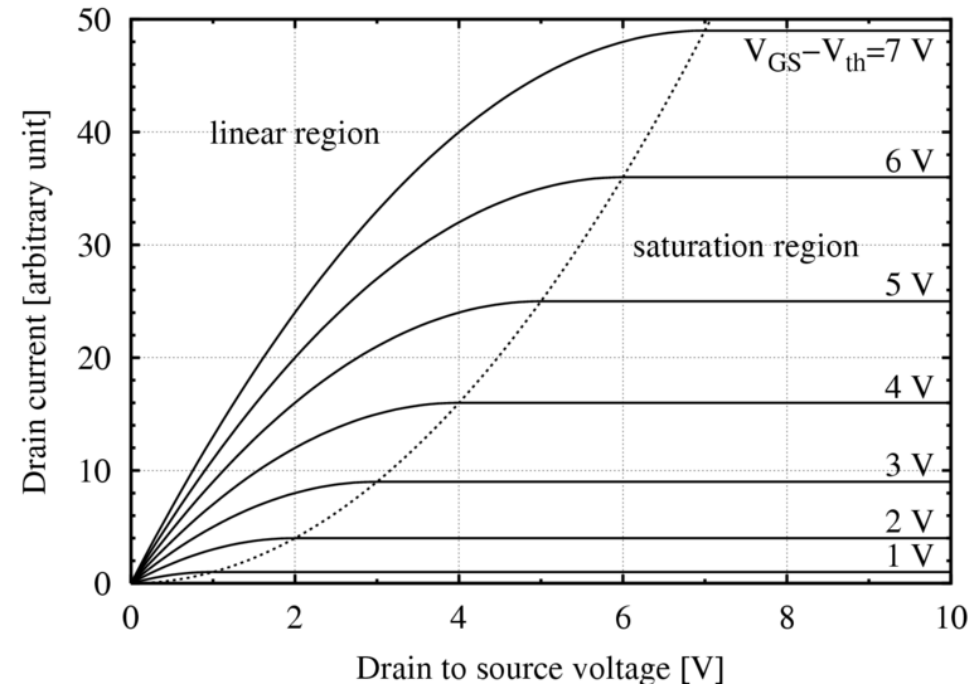
MOSFET – saturation voltage

$$I = \frac{Z}{L} \mu_n C_{ox} \left[(V_G - V_T) V_D - \frac{V_D^2}{2} \right]$$

At pinch-off, $dl_{ds}/dV_{ds} = 0$

$$\frac{dI}{dV_D} = \frac{Z}{L} \mu_n C_{ox} [(V_G - V_T) - V_D] = 0$$

$$V_{sat} = (V_G - V_T)$$



A MOSFET in saturation is a voltage controlled current source.

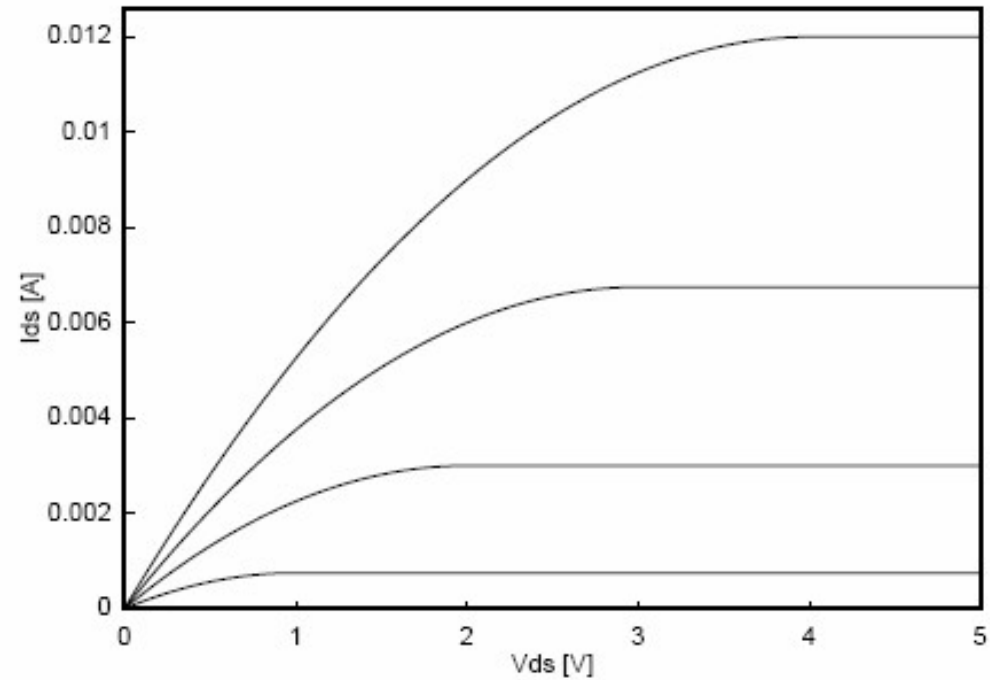
MOSFET – saturation current

Use the saturation voltage at pinch-off to determine the saturation current

$$V_{sat} = (V_G - V_T)$$

$$I = \frac{Z}{L} \mu_n C_{ox} \left[(V_G - V_T) V_D - \frac{V_D^2}{2} \right]$$

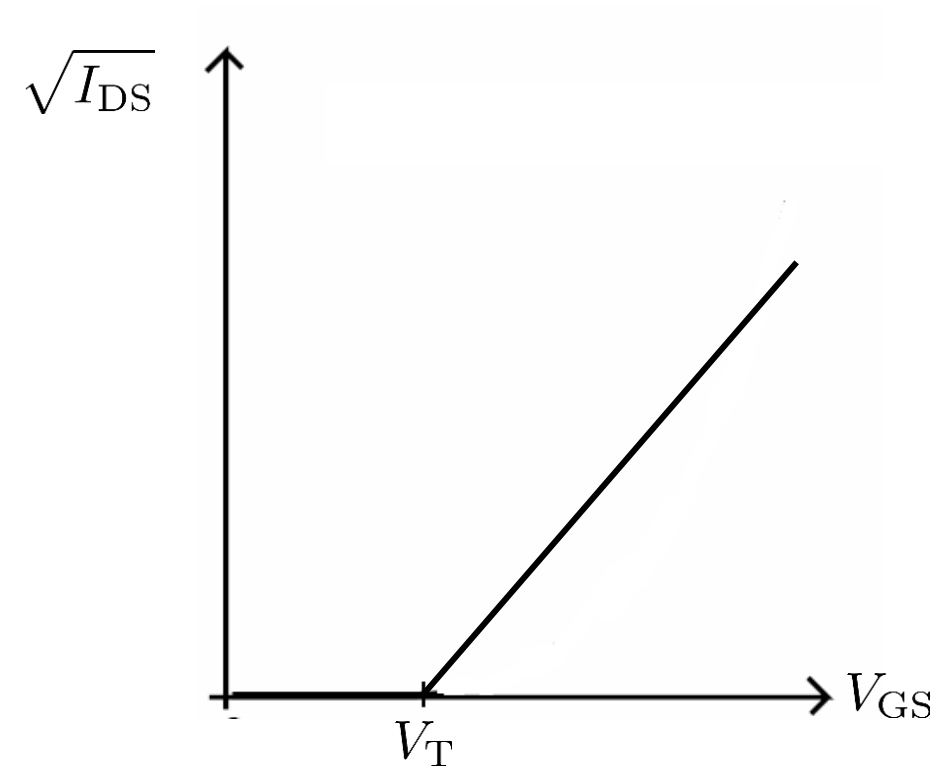
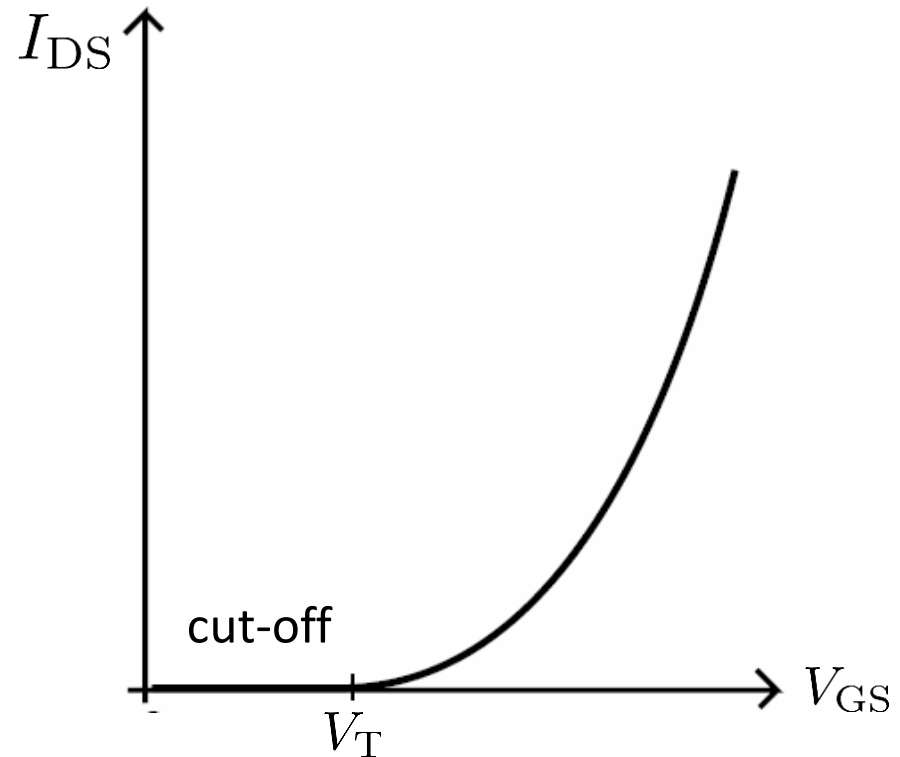
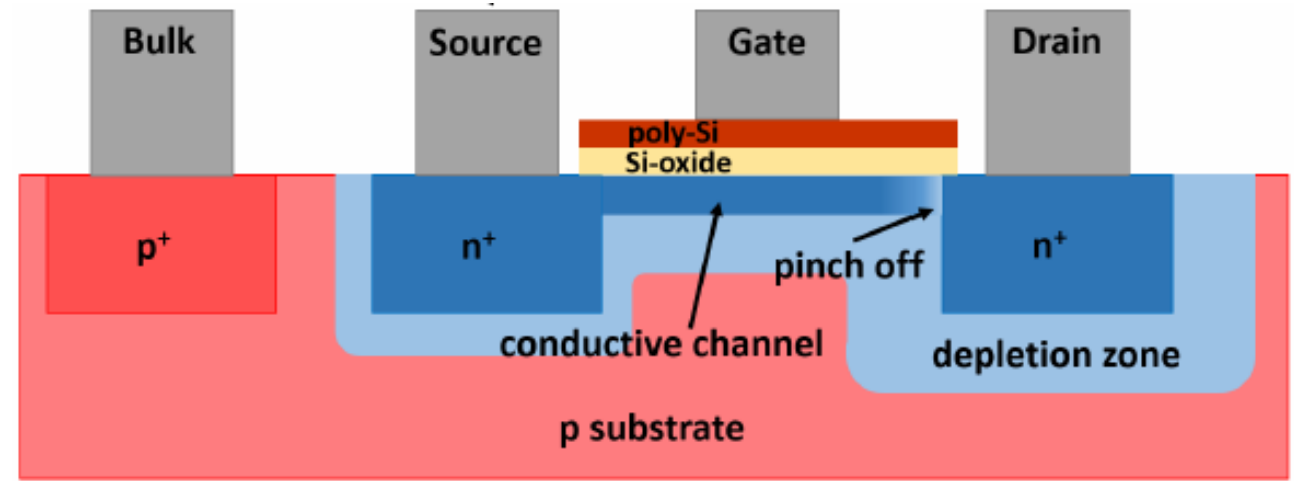
$$I_{sat} = \frac{Z}{2L} \mu_n C_{ox} (V_G - V_T)^2$$



MOSFET – saturation regime

$$I_{sat} = \frac{Z}{2L} \mu_n C_{ox} (V_{GS} - V_T)^2$$

$$V_{DS} \geq V_{DSsat} = V_G - V_T$$



MOSFET – linear regime

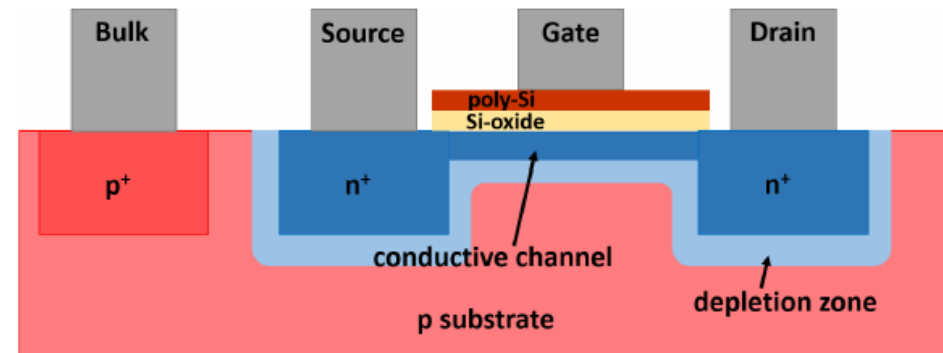
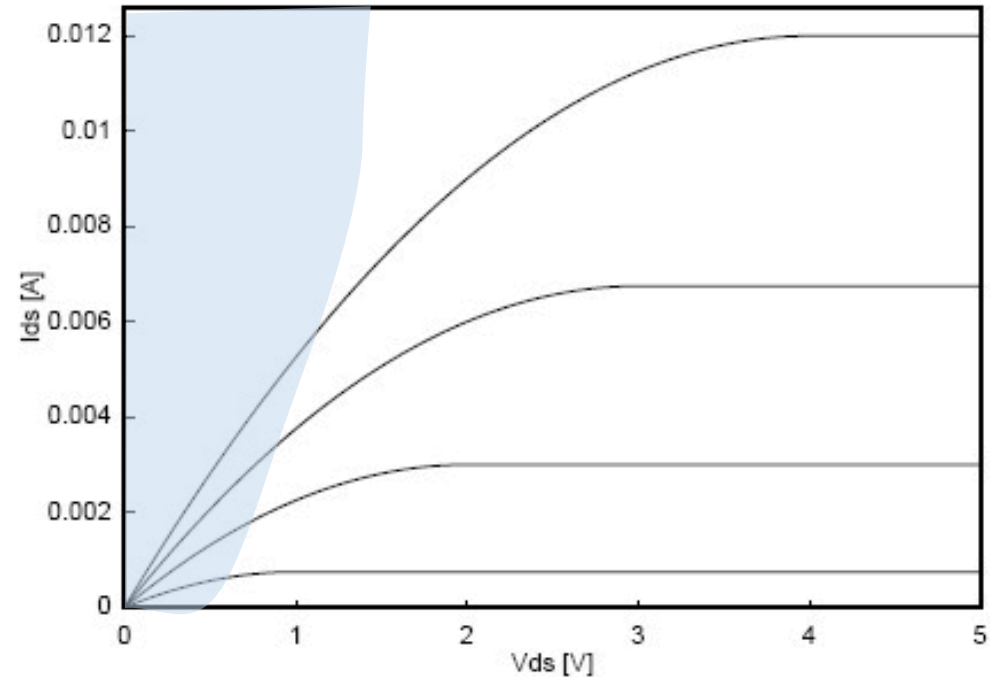
Channel conductance in the linear regime. For small V_D

$$I \approx \frac{Z}{L} \mu_n C_{ox} [(V_G - V_T) V_D]$$

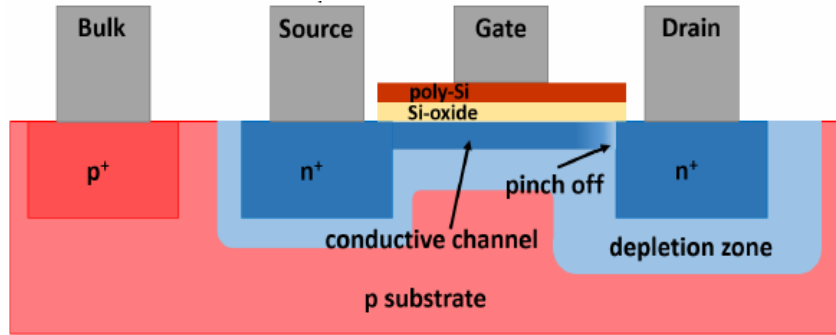
$$g_D = \frac{dI_D}{dV_D} = \frac{Z}{L} \mu_n C_{ox} (V_G - V_T)$$

Transconductance

$$g_m = \frac{dI_D}{dV_G} = \frac{Z}{L} \mu_n C_{ox} V_D$$



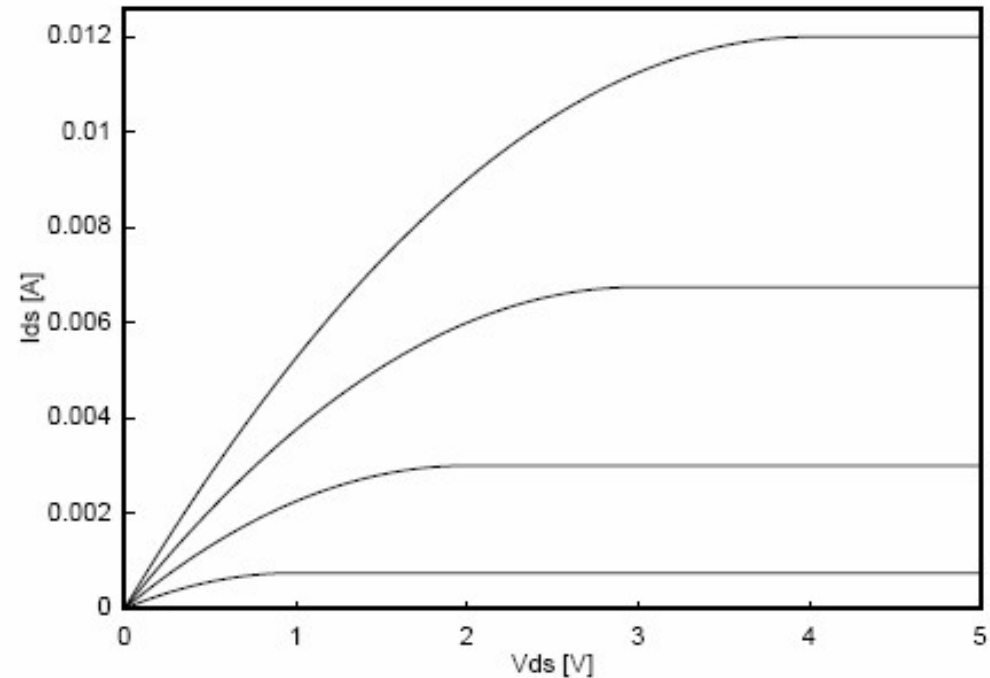
MOSFET – saturation regime



$$I_{sat} = \frac{Z}{2L} \mu_n C_{ox} (V_G - V_T)^2$$

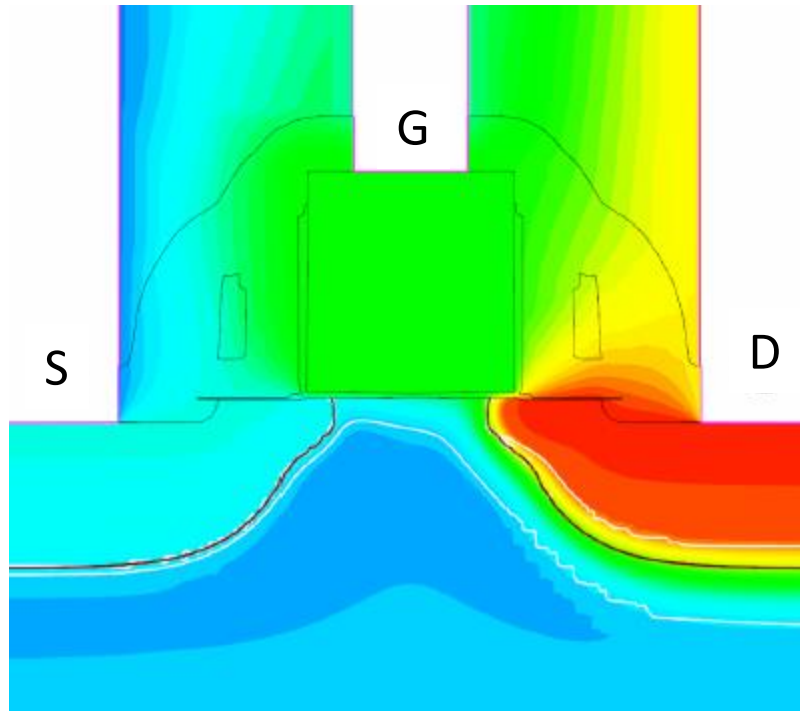
Transconductance

$$g_m = \frac{dI_D}{dV_G} = \frac{Z}{L} \mu_n C_{ox} (V_G - V_T)$$

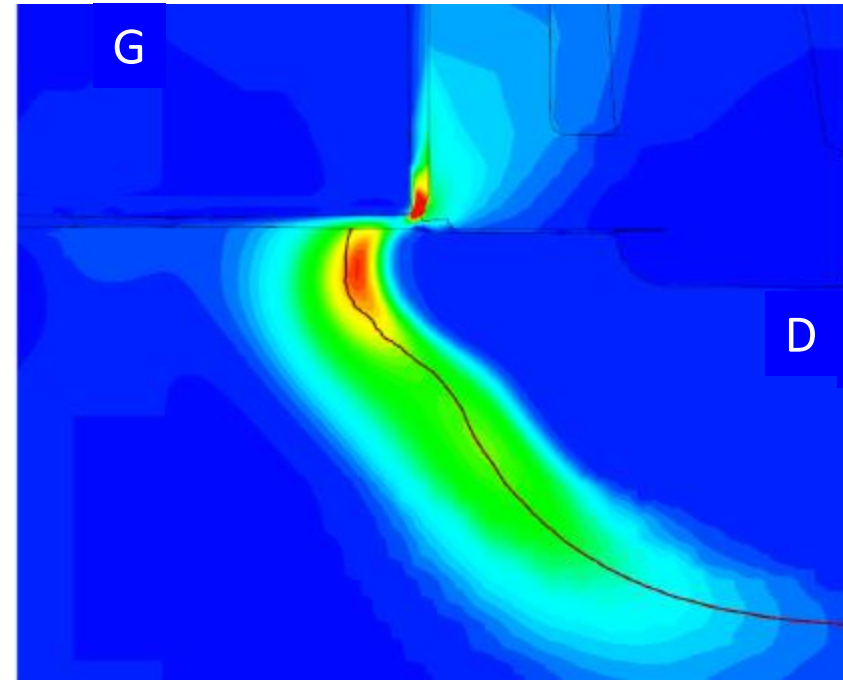


A MOSFET in the saturation regime acts like a voltage controlled current source.

MOSFET – saturation



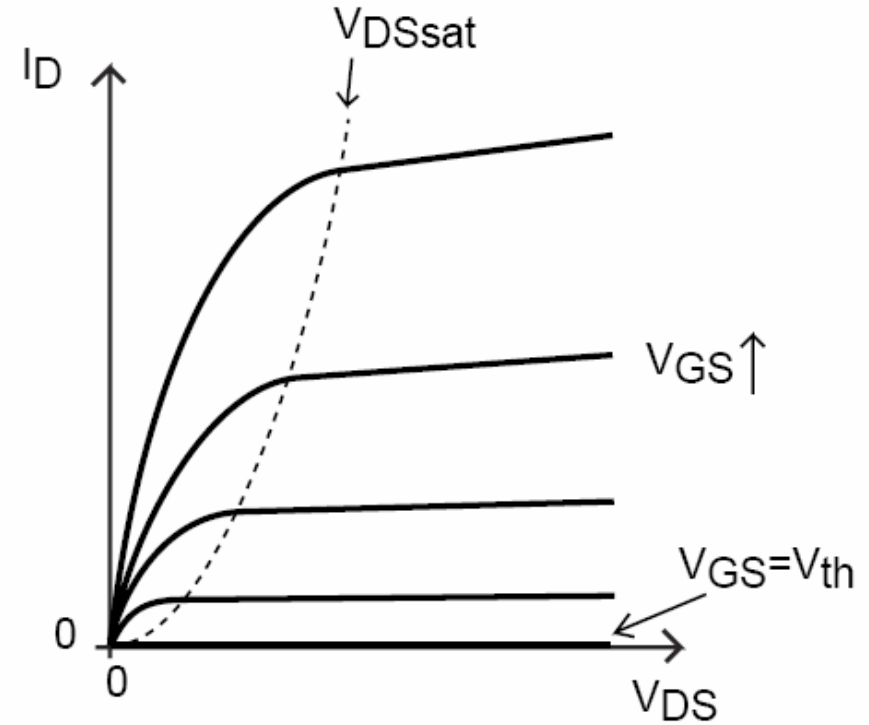
Potential



Electric field strength

MOSFET – saturation regime

$$I_{sat} = \frac{Z}{2L} \mu_n C_{ox} (V_G - V_T)^2 (1 - \lambda(V_D - V_{sat}))$$



Experimentally: channel length modulation

$$\lambda \propto \frac{1}{L}$$

high frequencies

$$\tilde{i}_{in} = 2\pi f C_G \tilde{v}_G$$

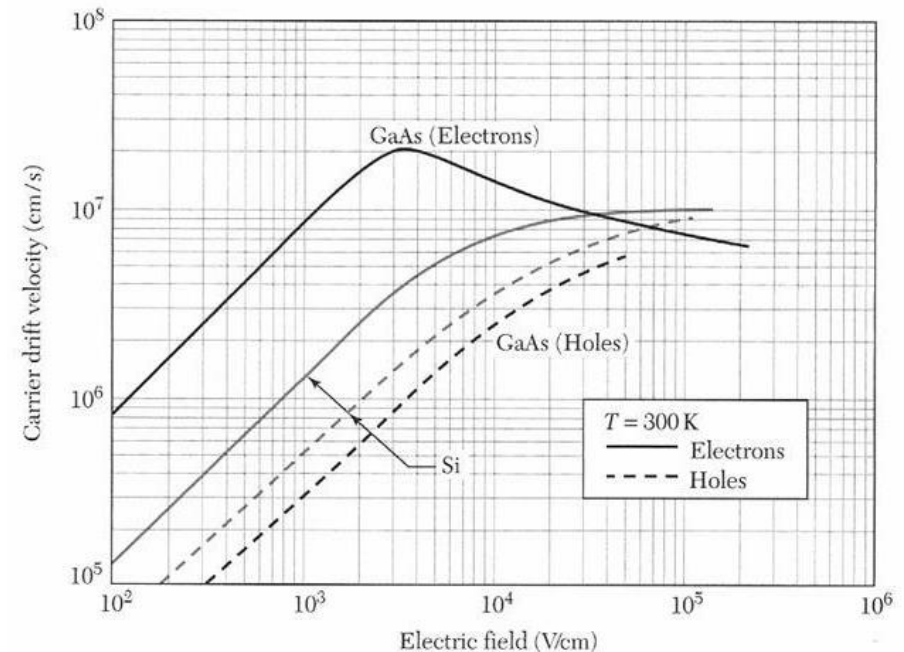
$$\tilde{i}_{out} = g_m \tilde{v}_G$$

$$\tilde{i}_{in} < \tilde{i}_{out}$$

$$f < \frac{g_m}{2\pi C_G} \propto \frac{1}{L^2} = f_T$$

For large E , Ohm's law ($j = ne\mu E$) is not valid.
The electron velocity saturates.
For velocity saturation:

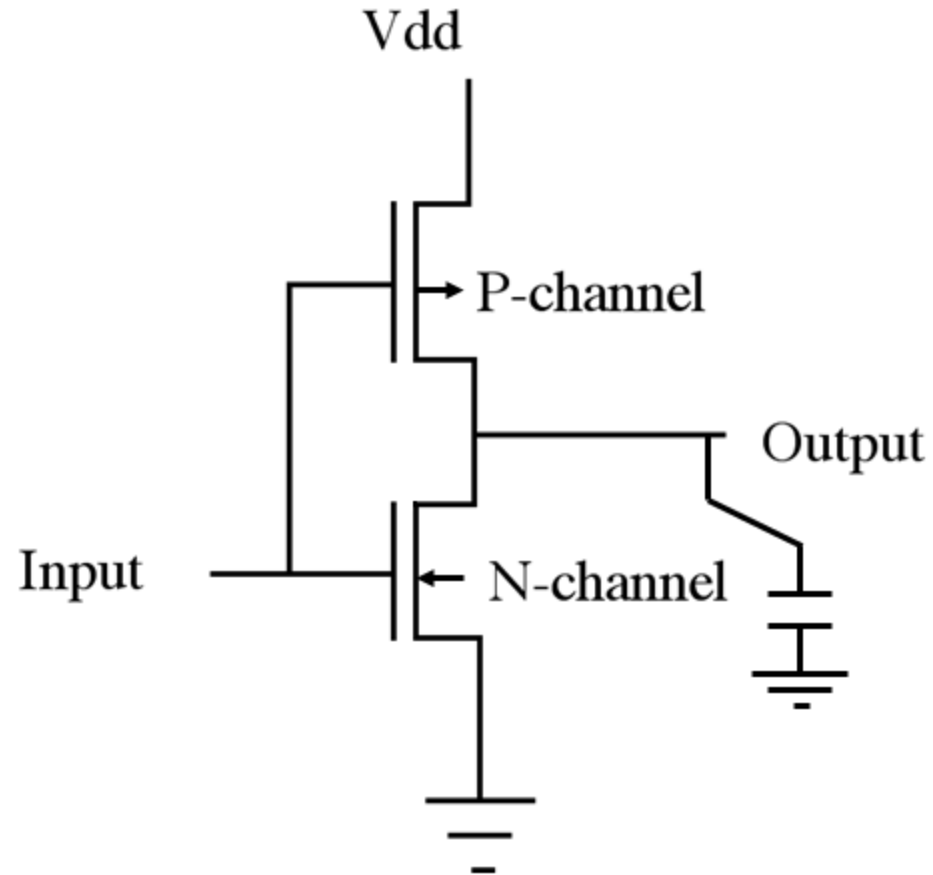
$$f_T \approx \frac{v_s}{L}$$



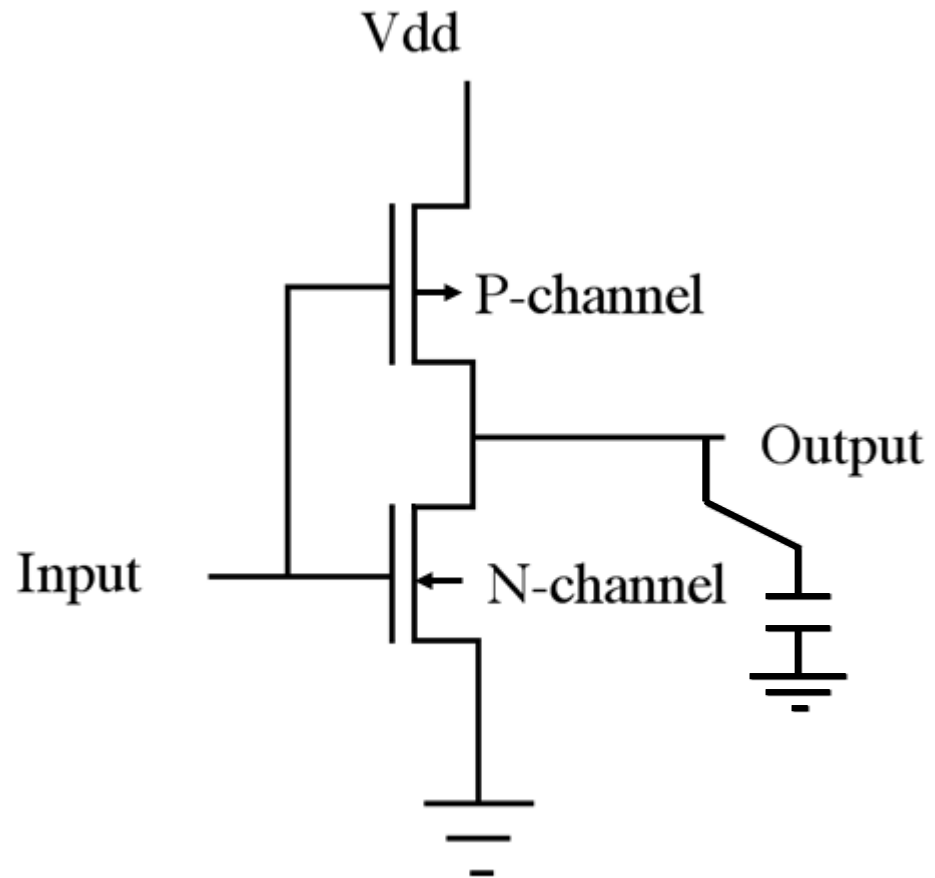
CMOS inverter

Dissipates little power except
when switching

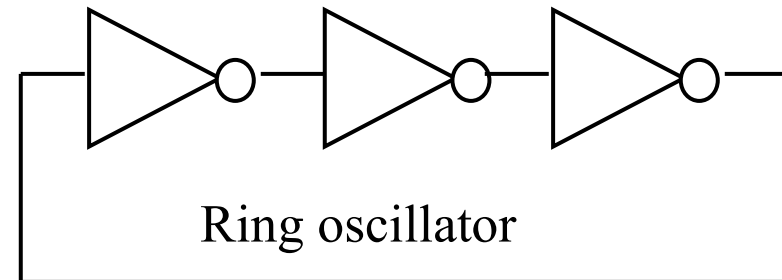
$$E = QV_{dd} = CV_{dd}^2$$



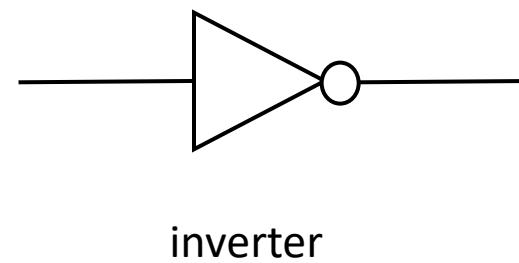
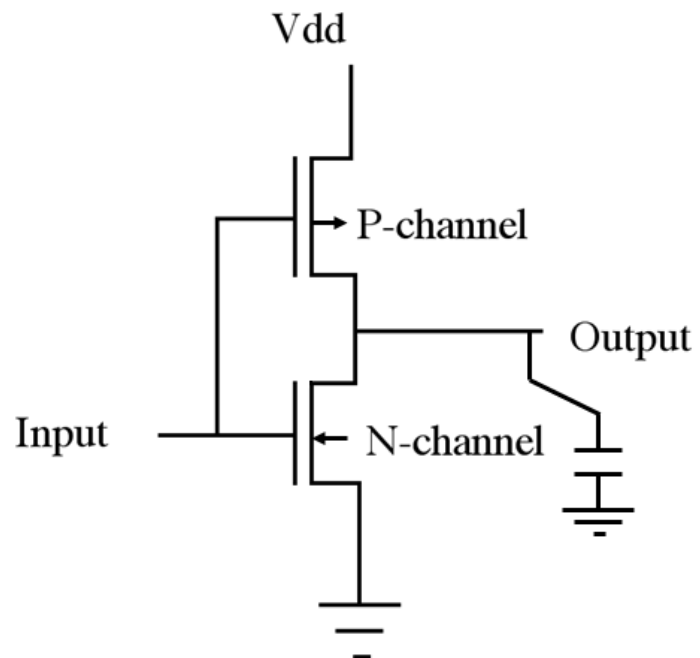
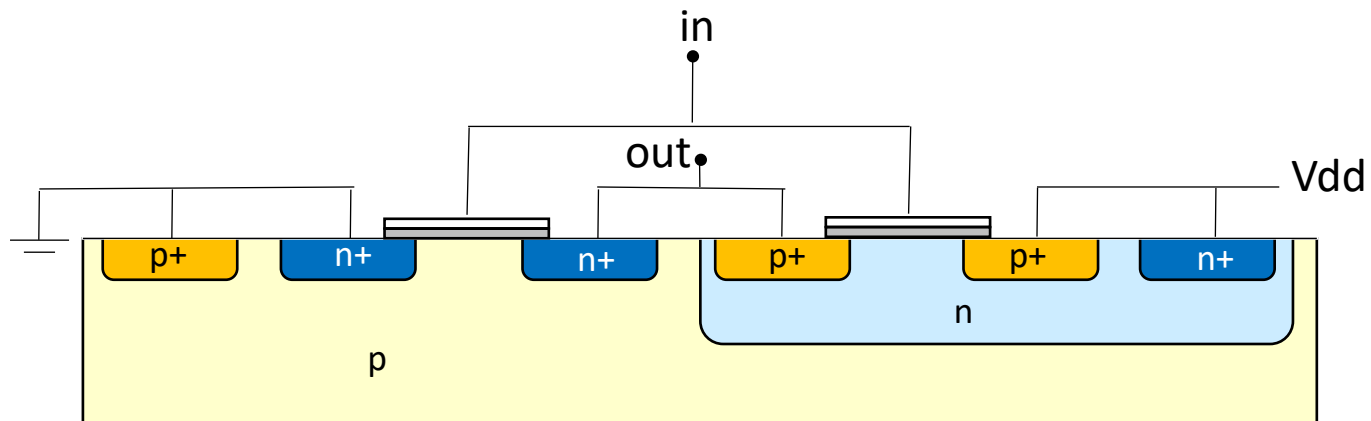
Gate delay



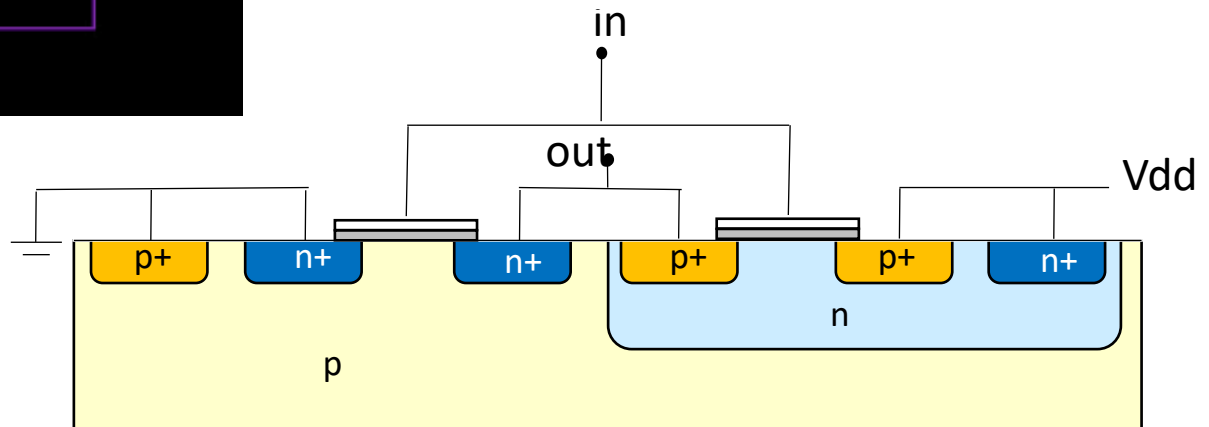
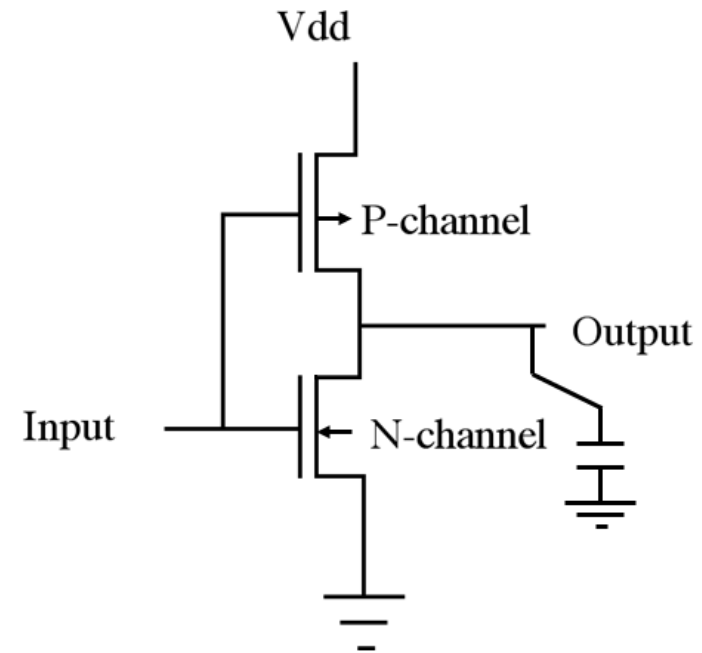
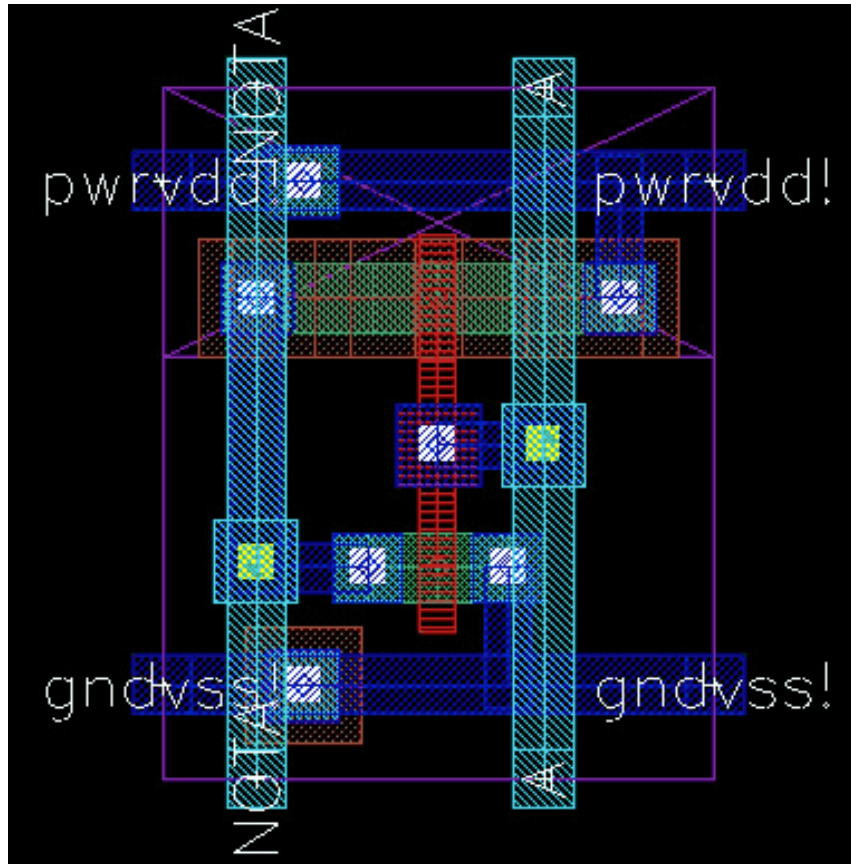
Gate delay is limited by $C_{gate}V_{dd}/I$.



CMOS inverter



CMOS inverter



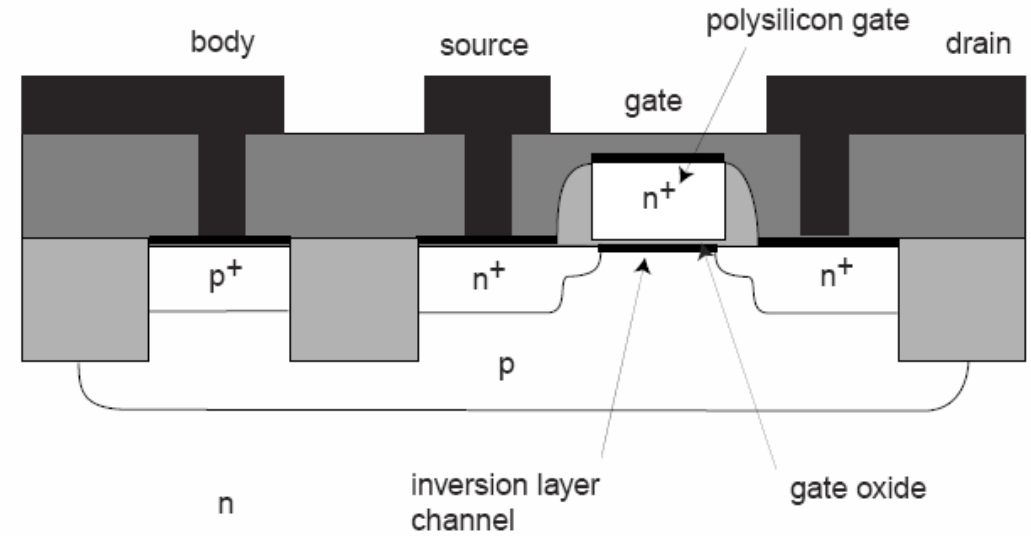
Our World
in DataOur World
in Data

50,000,000,000



By Max Roser, Hannah Ritchie - <https://ourworldindata.org/uploads/2020/11/Transistor-Count-over-time.png>, CC BY 4.0, <https://commons.wikimedia.org/w/index.php?curid=98219918>

Constant E-field Scaling



Gate length L , transistor width Z , oxide thickness t_{ox} are scaled down.

V_{ds} , V_{gs} , and V_T are reduced to keep the electric field constant.

Power density remains constant.

$$L \sim 45 t_{ox}$$

1975 - 1990: "Days of happy scaling"

Constant E-field Scaling

$$I_{sat} = \frac{Z}{2L} \mu_n \frac{\epsilon_{ox}}{t_{ox}} (V_G - V_T)^2$$

$$L \Rightarrow sL,$$

$$Z \Rightarrow sZ,$$

$$t_{ox} \Rightarrow st_{ox},$$

$$V_T \Rightarrow sV_T$$

$$I_{sat} \Rightarrow sI_{sat}$$

← I_{sat} gets smaller

$$g_m = \frac{dI_D}{dV_G} = \frac{Z}{L} \mu_n \frac{\epsilon_{ox}}{t_{ox}} (V_G - V_T)$$

← Transconductance stays the same.

Power per transistor decreases like L^2 . Power per unit area remains constant.

The heat dissipation problem

Microprocessors are hot ~ 100 C

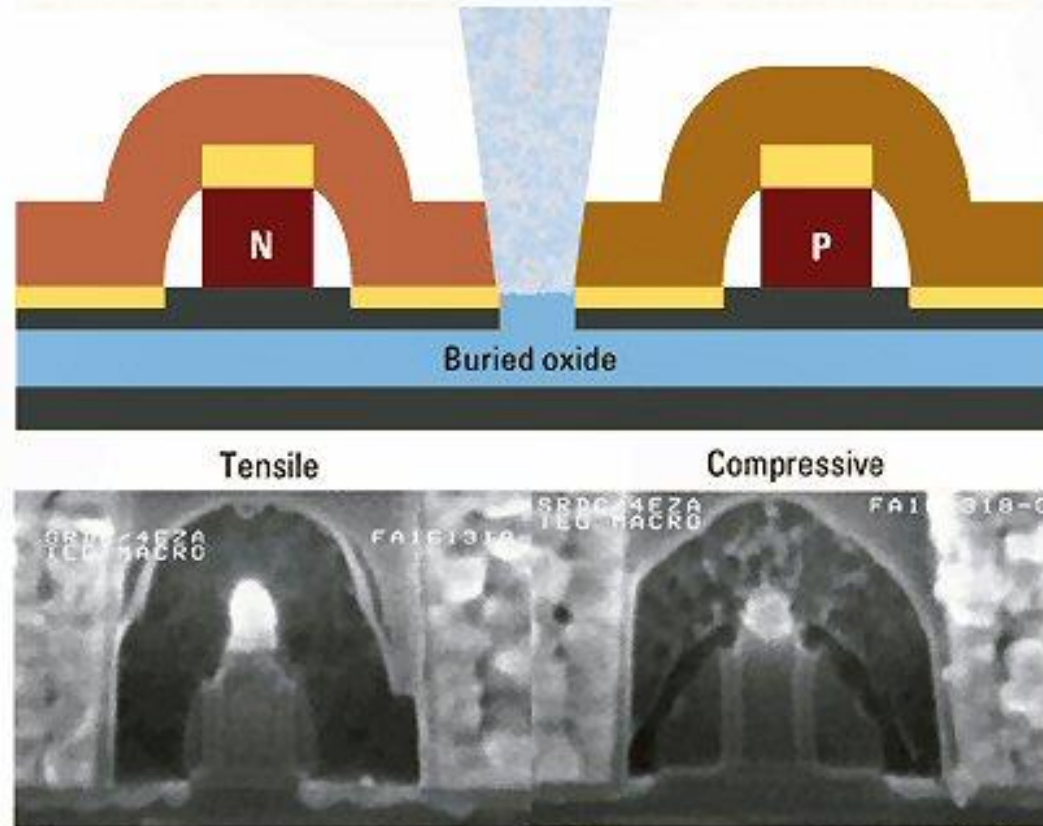
Hotter operation will cause dopants to diffuse

When more transistors are put on a chip they must dissipate less power.

Power per transistor decreases like L^2 .

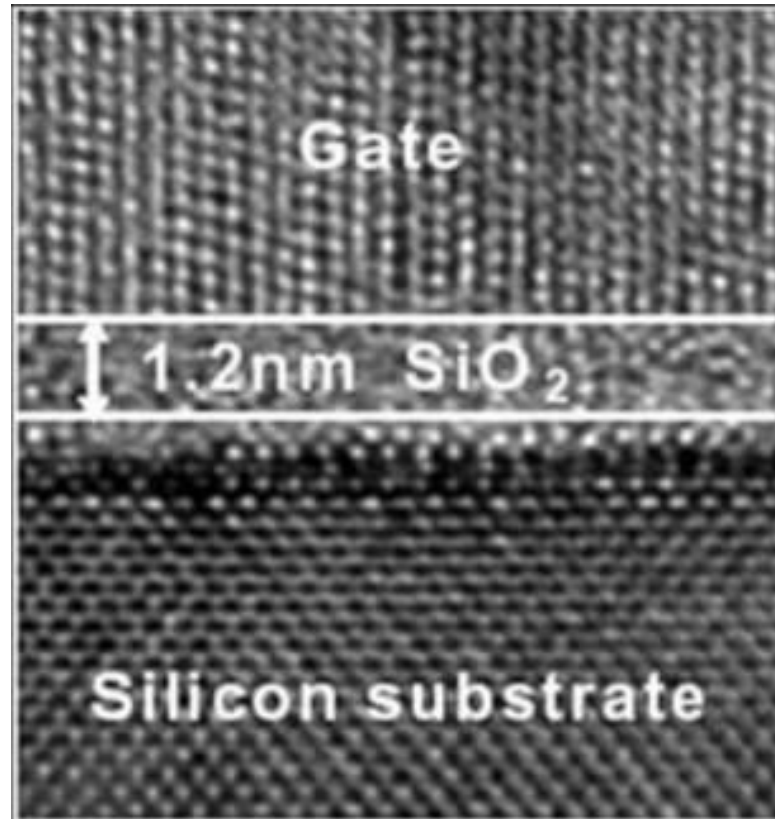
Dual stress liners

DUAL STRESS LINER TRANSISTOR CROSS-SECTION



Tensile silicon nitride film over the NMOS and a compressive silicon nitride film over the PMOS improves the mobility.

Gate dielectric

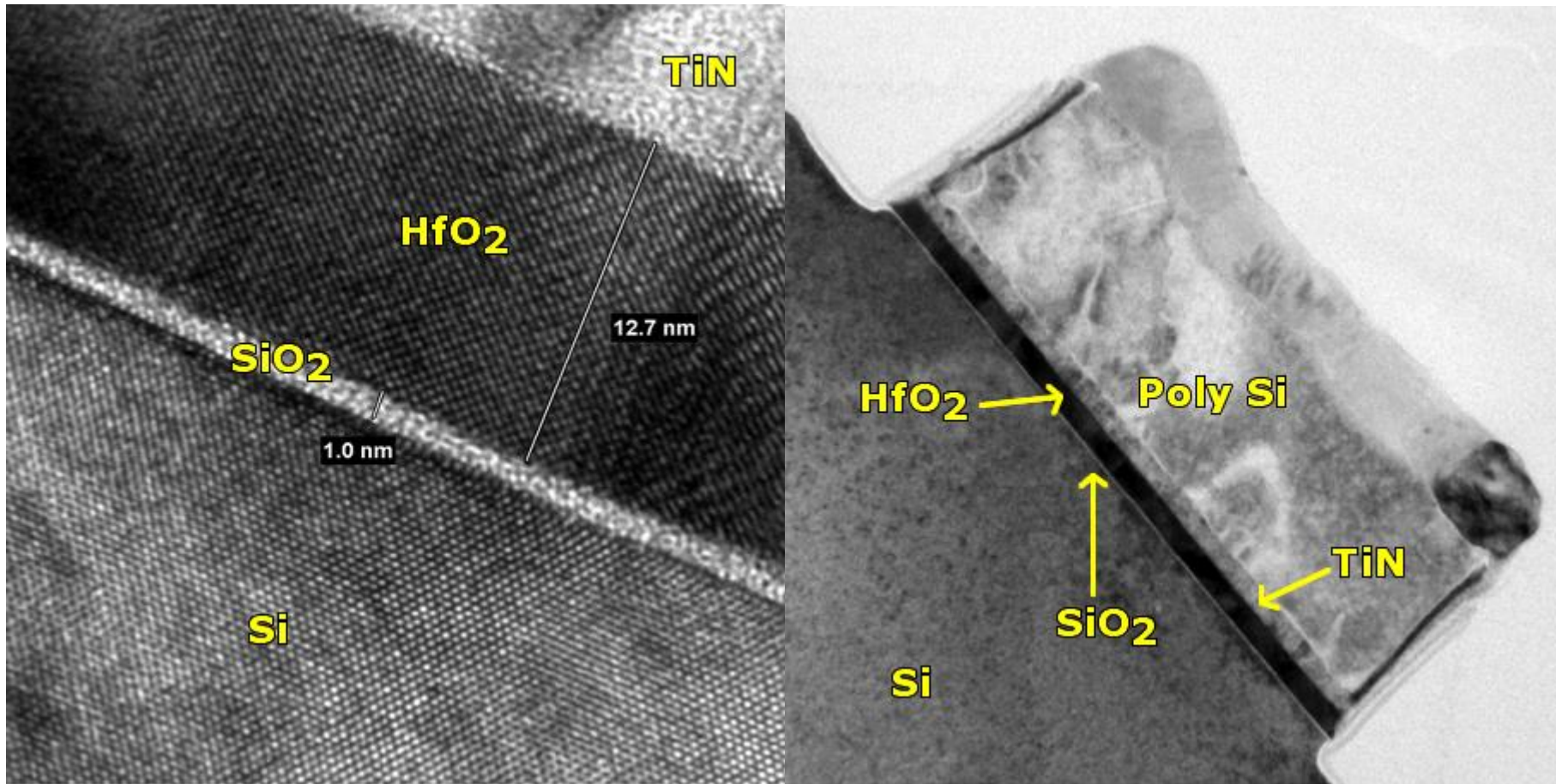


Thinner than 1 nm:
electrons tunnel

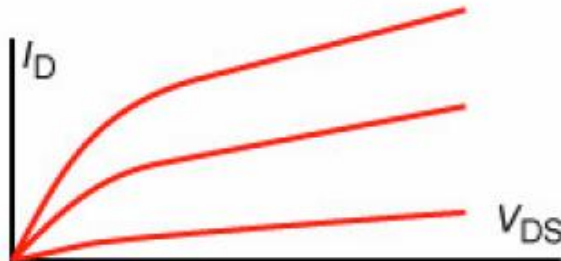
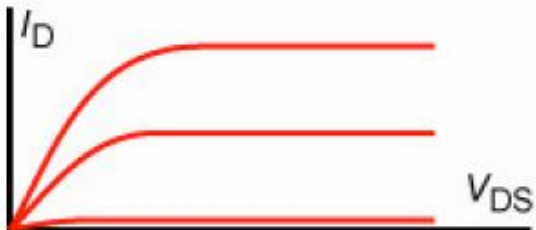
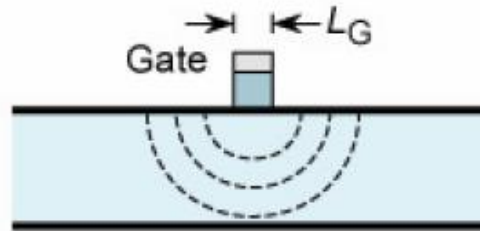
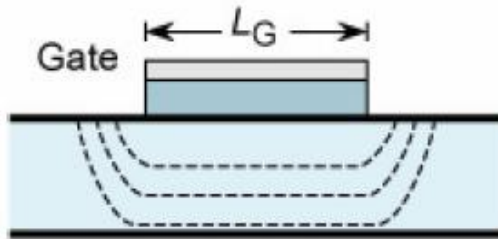
Large dielectric constant
desirable
 $\epsilon_r(\text{SiO}_2) \sim 4$

$\epsilon_r(\text{Si}_3\text{N}_4) \sim 7$

High-k dielectrics



Short channel effects



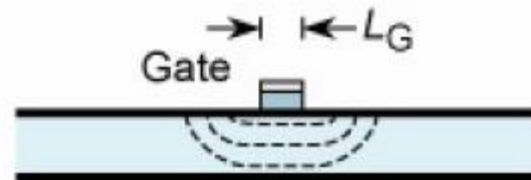
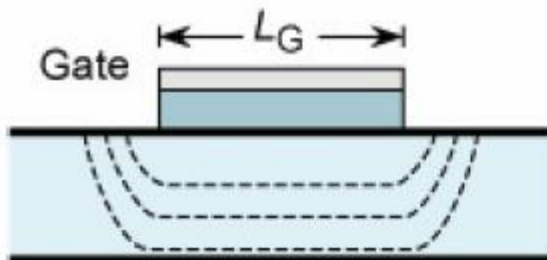
Short-channel effects:

Threshold-voltage shift

Lack of pinch-off

Increased leakage current

Increase of output conductance



SOI: silicon on insulator

CMOS SOI

(Semiconductor-on-insulator)

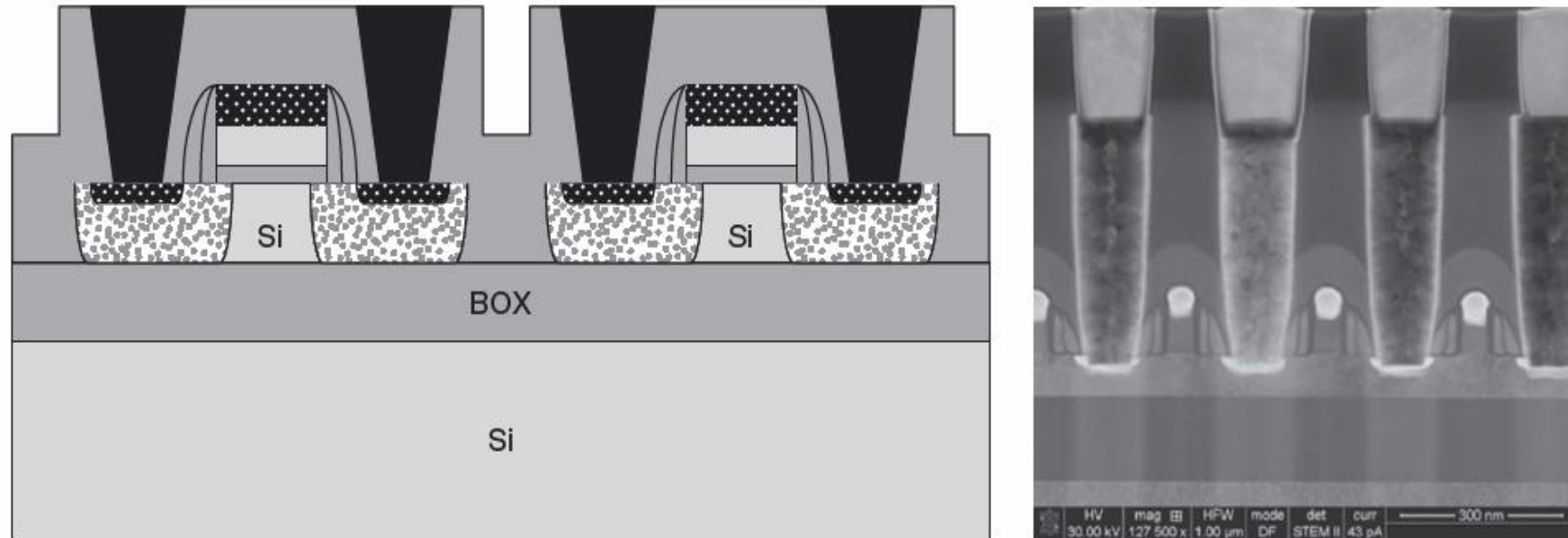
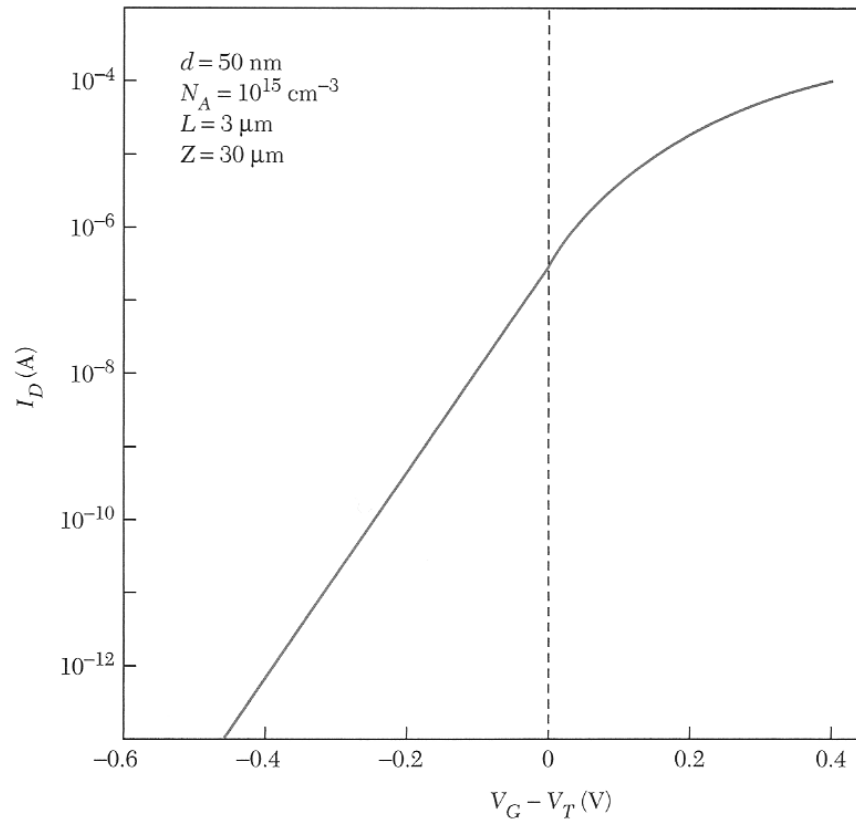


Figure 26.16 SOI MOSFET with first-level metal, schematic and TEM. Courtesy Brandon Van Leer, FEI Company⁴

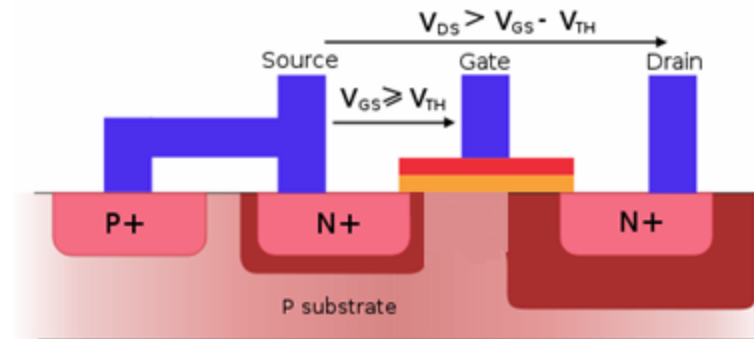
Subthreshold current

For $V_G < V_T$ the transistor should switch off but there is a diffusion current. The current is not really off until ~ 0.5 V below the threshold voltage.



Weak inversion

$$I_D \propto \exp\left(\frac{e(V_G - V_T)}{k_B T}\right)$$



Subthreshold slope: 70-100 mV/decade

Subthreshold current

$$x_p = -\frac{\epsilon_s}{\epsilon_{\text{ox}}} t_{\text{ox}} + \sqrt{\left(\frac{\epsilon_s}{\epsilon_{\text{ox}}} t_{\text{ox}}\right)^2 + \frac{2\epsilon_s}{eN_A} (V_g - V_{fb})}$$

$$I_D \approx \frac{k_B T \mu W n_{2d}}{L} = \frac{n_i^2 \mu \epsilon_s k_B^2 T^2 W}{e^2 N_A^2 x_p L} \exp\left(\frac{e^2 N_A x_p^2}{2\epsilon_s k_B T}\right)$$

